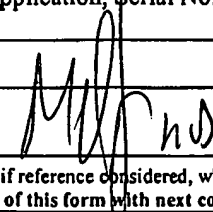


INFORMATION DISCLOSURE CITATION (USE SEVERAL SHEETS IF NECESSARY)	ATTY DOCKET NO. POU920040003US1	SERIAL NO. UNKNOWN
	APPLICANT(S) CHU ET AL.	Express Mail Label # ER363646791 US
	FILING DATE HEREWITH 3/30/06	GROUP 3744 UNKNOWN

U.S. PATENT DOCUMENTS							
*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
mf	AA	5,036,677	08/06/1991	Neuenfeldt et al.	62	259	
mf	AB	5,884,489	03/23/1999	Hughes et al.	62	3.4	
mf	AC	6,167,947 B1	01/02/2001	Hokanson et al.	165	80.3	
mf	AD	6,233,959 B1	05/22/2001	Kang et al.	62	259.2	
mf	AE	6,542,361 B2	04/01/2003	Paradis	361	687	

FOREIGN PATENT DOCUMENTS									
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION		
							NO	Yes	ABSTRACT
M	AF	GB 2,129,113 A	10/12/1983	GB	F25D	13/00	X		

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	
mf	AG Chu et al., "Method and Apparatus For Combined Air and Liquid Cooling Of Stacked Electronics Components", pending U.S. patent application, Serial No. 10/303,284, filed November 25, 2002.
mf	AH Chu et al., "Method and System For Cooling Electronics Racks Using Pre-Cooled Air", pending U.S. patent application, Serial No. 10/612,355, filed July 2, 2002.

EXAMINER 	DATE CONSIDERED 6/26/06
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EXAMINER: Initial here if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.